

116-93-624-41-007000

116-93-624-41-007000 Information

Heisener.com	116-93-624-41-007000 Mill-Max Manufacturing Corp. Connectors, Interconnects Sockets for ICs, Transistors CONN IC DIP SOCKET 24POS GOLD - For the pricing/inventory/lead time, please contact	
For Reference Only	us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



116-93-624-41-007000 Specifications

Manufacturer Part Number116-93-624-41-007000ManufacturerMill-Max Manufacturing Corp.CategoryConnectors, InterconnectsPackage-Package16TypeDIP,0.6" (15.24mm) Row SpacingNumber of Positions or Pins (Grid)24 (2 x 12)Pitch - MatingOlo0" (2.54mm) Acoustication (2000)Contact Finish - MatingGoldContact Finish Thickness - MatingBeryllium CopperNuming TypeHrough HoleFeaturesElevated, Open FrameFortinationSolderPitch - Post0.100" (2.54mm)Contact Finish Thickness - MatingBeryllium CopperMunting TypeHrough HoleFeaturesElevated, Open FrameFortinationSolderOrticat Finish - Post0.100" (2.54mm)Contact Finish - PostSolderContact Finish - PostSolderContact Finish - PostSolderFundationSolderContact Finish - PostSolderContact Finish - PostSolderContact Finish - PostSolderContact Finish - PostSolderContact Finish Thickness - PostBrass AlloyHousing Material - PostFarse AlloyHousing Material - PostSolderContact Finish Thickness - PostSolderContact Finish Thickness - PostSolderContact Finish Thickness - PostSolderContact Finish Thickness - PostSolderContact Material - PostSolderContact Finish			
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	Contact Material - Post	Brass Alloy	
Operating Temperature $-55^{\circ}C \sim 125^{\circ}C$	Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	
	Operating Temperature	-55°C ~ 125°C	
Report errors?			Report errors?

116-93-624-41-007000 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

116-93-624-41-007000 Payment Methods





If you have any question about 116-93-624-41-007000, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com